

FDPF14N30 N-Channel UniFET[™] MOSFET

300 V, 14 A, 290 mΩ

Features

- $R_{DS(on)}$ = 290 m Ω (Max.) @ V_{GS} = 10 V, I_D = 7A
- Low Gate Charge (Typ. 18 nC)
- Low C_{rss} (Typ. 17 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability

Applications

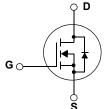
- PDP TV
- Uninterruptible Power Supply

March 2013

Description

UniFETTM MOSFET is Fairchild Semiconductor[®], s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





Absolute Maximum Ratings

Symbol		Parameter		FDPF14N30	Unit
V _{DSS}	Drain-Source Voltage		irce Voltage 300		V
I _D	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	,	14 * 8.4 *	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	56 *	А
V _{GSS}	Gate-Source voltage			±30	V
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	330	mJ
I _{AR}	Avalanche Current		(Note 1)	14	А
E _{AR}	Repetitive Avalanche Energy		(Note 1)	14	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate above 25°C		35 0.28	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		se,	300	°C

* Drain current limited by maximum junction temperature Thermal Characteristics

Symbol	Parameter	FDPF14N30	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max 3.56		°C M/	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max	62.5	°C/W	

DPF14N30
N-Channel
UniFET TM
MOSFET

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDPF14N30	FDPF14N30	TO-220F	-	-	50

Electrical Characteristics $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Unit
Off Charac	teristics					
BV _{DSS}	Drain-Source Breakdown Voltage	e Breakdown Voltage $V_{GS} = 0V, I_D = 250 \mu A$				V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, Referenced to 25°C		0.3		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 300V, V_{GS} = 0V$ $V_{DS} = 240V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 7A		0.24	0.29	Ω
9 _{FS}	Forward Transconductance V _{DS} = 40V, I _D = 7A			10.5		S
Dynamic C	Characteristics	-				
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V,		815	1060	pF
C _{oss}	Output Capacitance	f = 1.0MHz		150	195	pF
C _{rss}	Reverse Transfer Capacitance			17	25	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 150V, I _D = 14A		20	50	ns
t _r	Turn-On Rise Time	$R_{G} = 25\Omega$		105	120	ns
t _{d(off)}	Turn-Off Delay Time			30	70	ns
t _f	Turn-Off Fall Time	(Note 4)		75	160	ns
Qg	Total Gate Charge	V _{DS} = 240V, I _D = 14A		18	25	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		4.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		8		nC
Drain-Sour	rce Diode Characteristics and Maximur	n Ratings			1	
I _S	Maximum Continuous Drain-Source Diode Forward Current				14	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				56	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _S = 14A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 14A		235		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100A/μs		1.6		μC

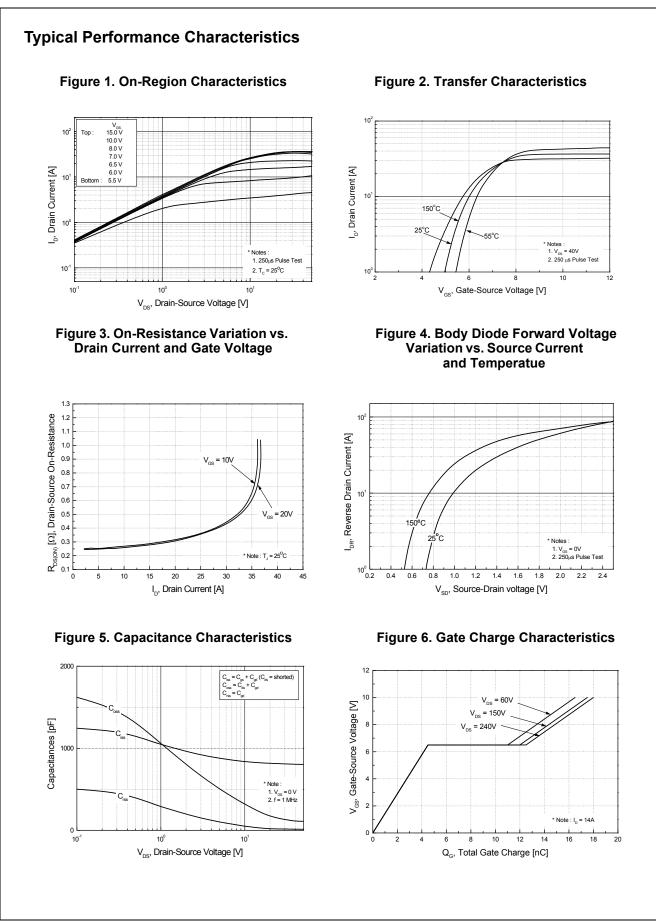
NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 2.8mH, I_{AS} = 14A, V_DD = 50V, R_G = 25 Ω , Starting T_J = 25°C

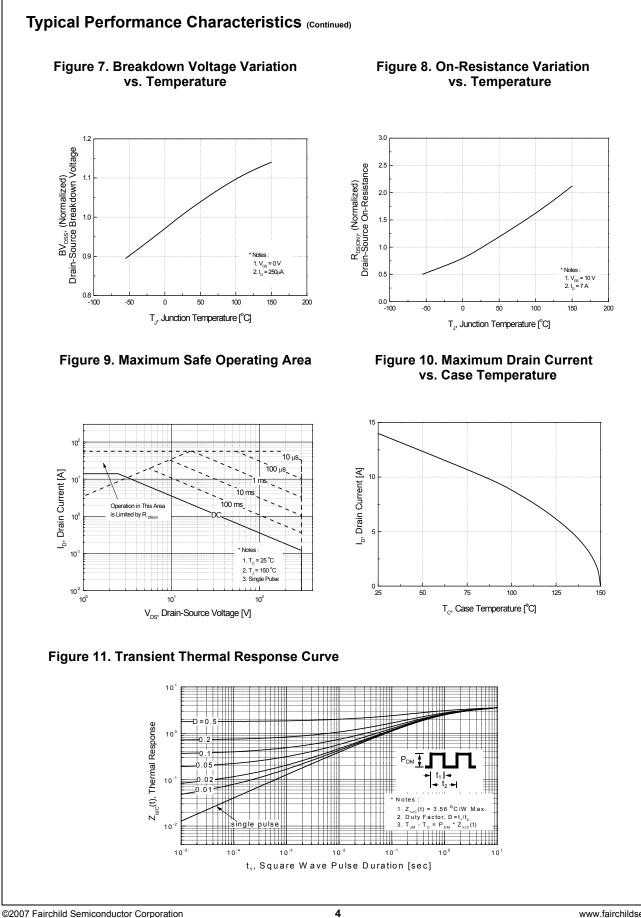
3. $I_{SD} \leq$ 14A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS}, \; Starting \; T_J$ = 25°C

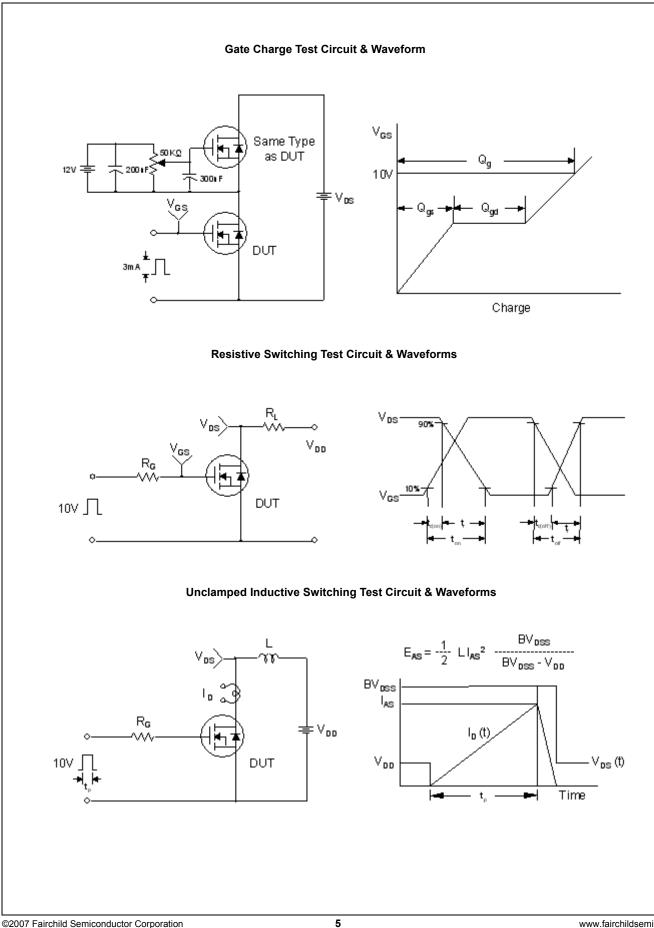
4. Essentially Independent of Operating Temperature Typical Characteristics



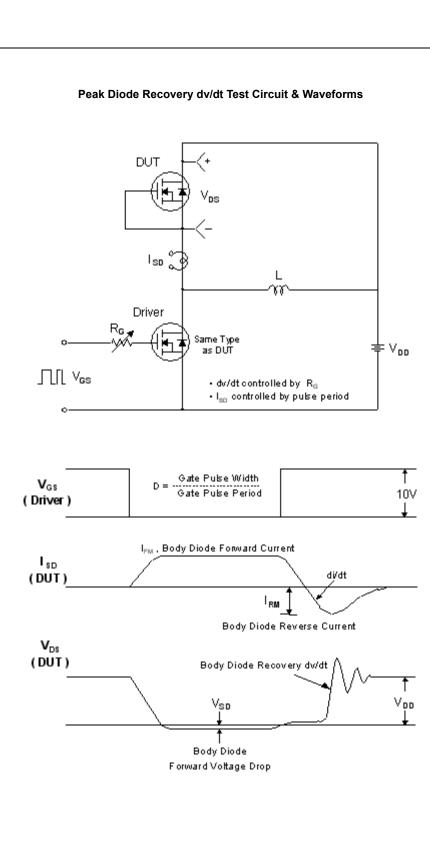
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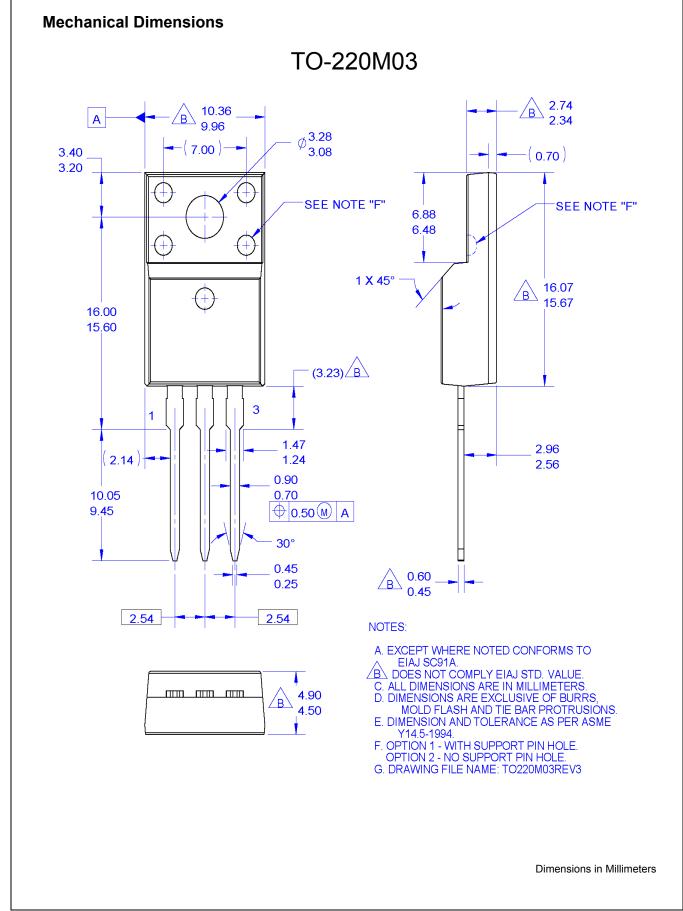




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